

# 产品规格承认书

## SPECIFICATIONS

客户:

CUSTOMER: \_\_\_\_\_

产品名称:

DESCRIPTION: \_\_\_\_\_ 蓝牙天线

客户型号:

CUSTOMER PART No: \_\_\_\_\_

产品型号:

OUR MODEL NO: \_\_\_\_\_ **PBX3216MP01**

日期:

DATE: \_\_\_\_\_ 2020/12/22

确认签字, 盖章后请返回承认书一份

PLEASE RETURN TO US ONE COPY OF "SPECIFICATION FOR APPROVAL"  
WITH YOUR APPROVED SIGNATURES

|    |  |    |    |    |     |
|----|--|----|----|----|-----|
| 核准 |  | 审核 | 刘飞 | 制作 | 刘小美 |
|----|--|----|----|----|-----|

|        |  |
|--------|--|
| 客户承认签印 |  |
| 日期     |  |

|                                                                                                     |                 |                                                                                                                                                                                                       |           |
|-----------------------------------------------------------------------------------------------------|-----------------|-------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|-----------|
| UNLESS OTHER SPECIFIED TOLERANCES ON:<br>X=±      X.X=±      X.XX=±<br>ANGLES = ±      HOLE DIA = ± |                 |  深圳市朋伴兴业科技有限公司                                                                                                     |           |
| SCALE: N/A                                                                                          | UNIT: mm        | THESE DRAWINGS AND SPECIFICATIONS ARE THE PROPERTY OF PBXY TECHNOLOGY Limited AND SHALL NOT BE REPRODUCED OR USED AS THE BASIS FOR THE MANUFACTURE OR SALE OF APPARATUS OR DEVICES WITHOUT PERMISSION |           |
| DRAWN BY: Sera                                                                                      | CHECKED BY: XD  |                                                                                                                                                                                                       |           |
| DESIGNED BY: Sera                                                                                   | APPROVED BY: XD |                                                                                                                                                                                                       |           |
| TITLE: CHIP2450-3216 Specification                                                                  |                 | DOCUMENT NO.                                                                                                                                                                                          | SPEC REV. |
|                                                                                                     |                 | 3216                                                                                                                                                                                                  | P1        |

## PBX3216MP01 Specification

Operating Temp. : -40℃~+85℃

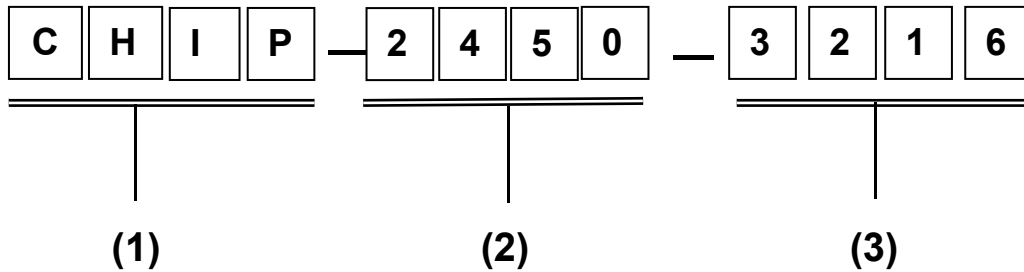
### 1. FEATURES:

- Light weight, compact
- Wide bandwidth, low cost
- Built-in antenna with high gain

### 2. APPLICATIONS:

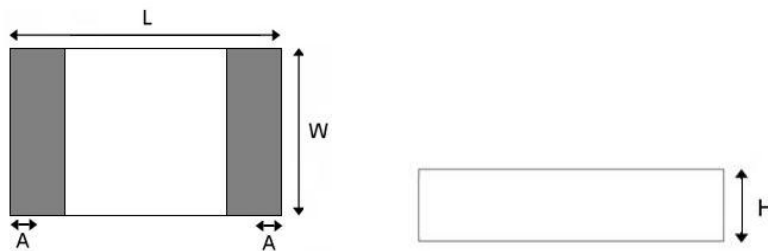
- Bluetooth, Wireless LAN, Mobile TV
- Home RF System, etc

### 3. PRODUCT IDENTIFICATION



- (1) Product type: Multilayer chip Antenna  
 (2) Center Frequency: 2450MHz  
 (3) External Dimensions (L×W) (mm): 3.2\*1.6

### 4. SHAPE AND DIMENSIONS:



| L       | W       | H        | A       |
|---------|---------|----------|---------|
| 3.2±0.2 | 1.6±0.2 | 0.52±0.1 | 0.4±0.1 |

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SCALE: N/A

UNIT: mm

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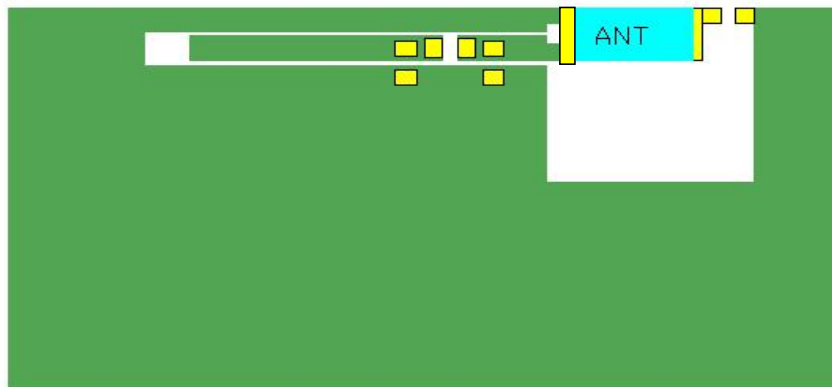
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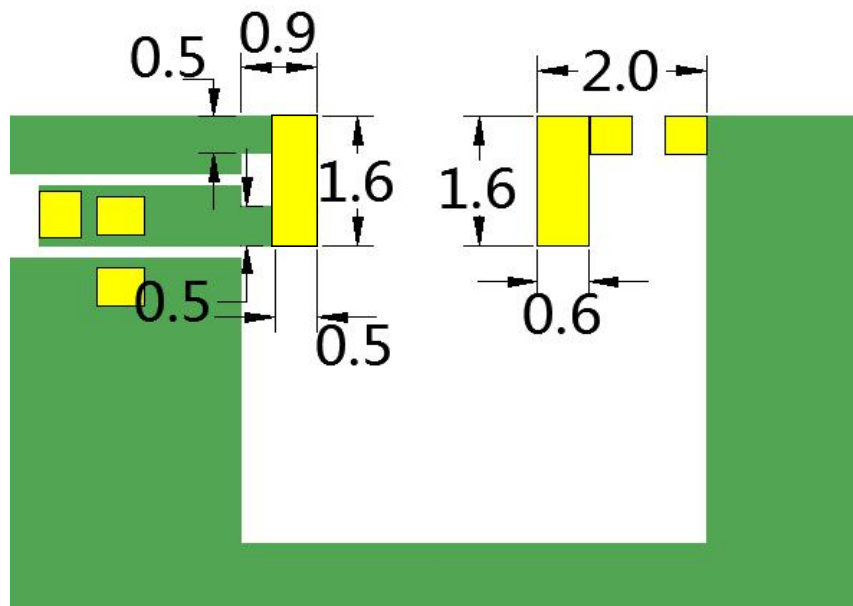
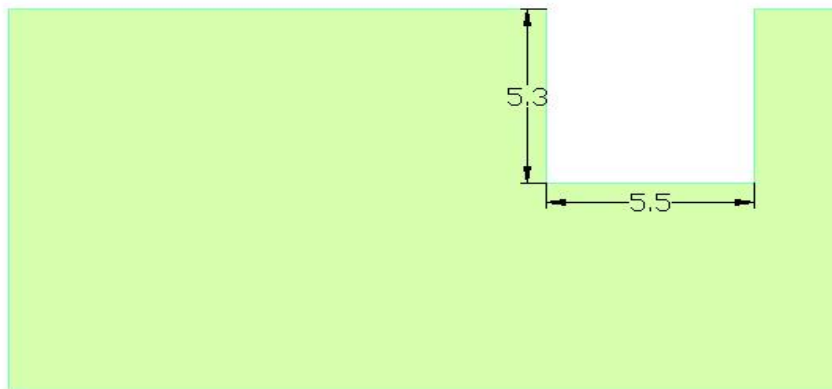
P1

测试板参考尺寸:

单位: mm



天线  
PAD  
底层铺铜  
顶层铺铜



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ANGLES = ±

HOLE DIA = ±



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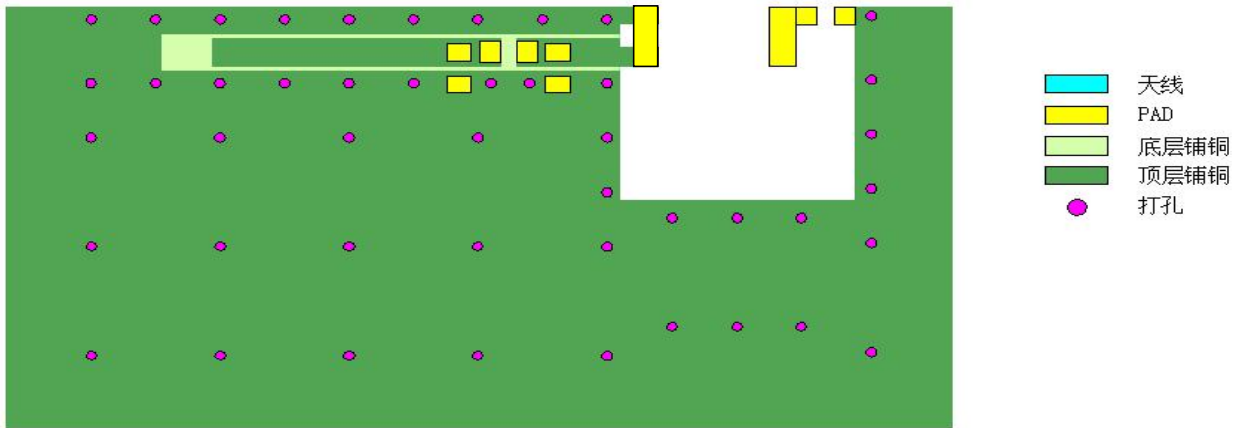
DOCUMENT NO.

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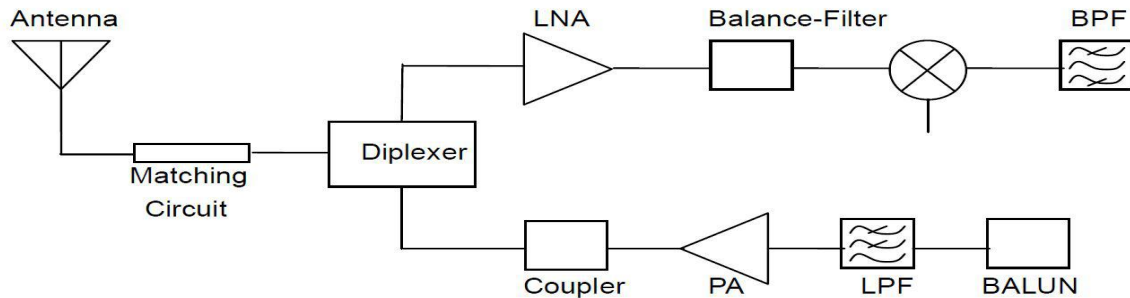
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打孔参考示意图



## APPLICATION GUIDE



## 5. SPECIFICATIONS:

| 测试项   | 规格           |
|-------|--------------|
| 带宽    | 2400~2483MHz |
| 极化方式  | 线极化          |
| *最大增益 | 2.67dBi      |
| *效率   | 72.30%       |
| 输入阻抗  | 50 Ω         |

\* Test condition: Test board size 90\*40 mm

Matching circuit: Pi matching circuit will be required

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SCALE: N/A

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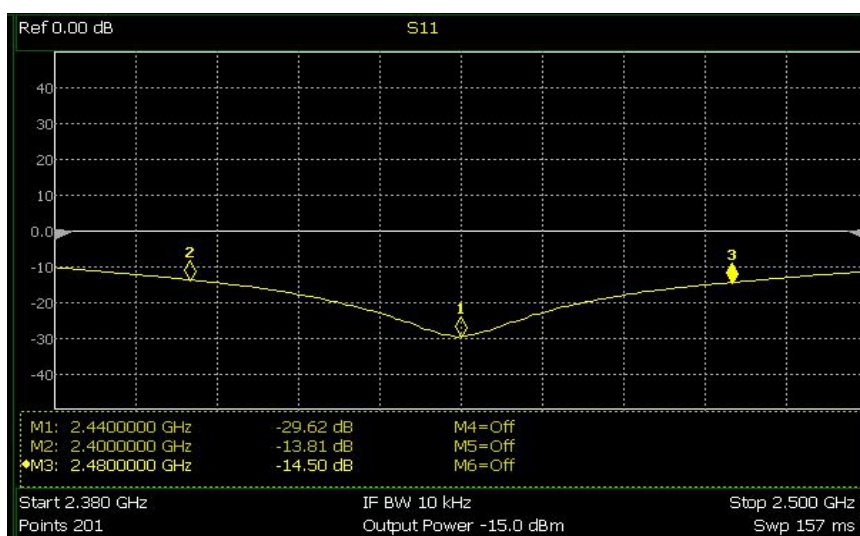
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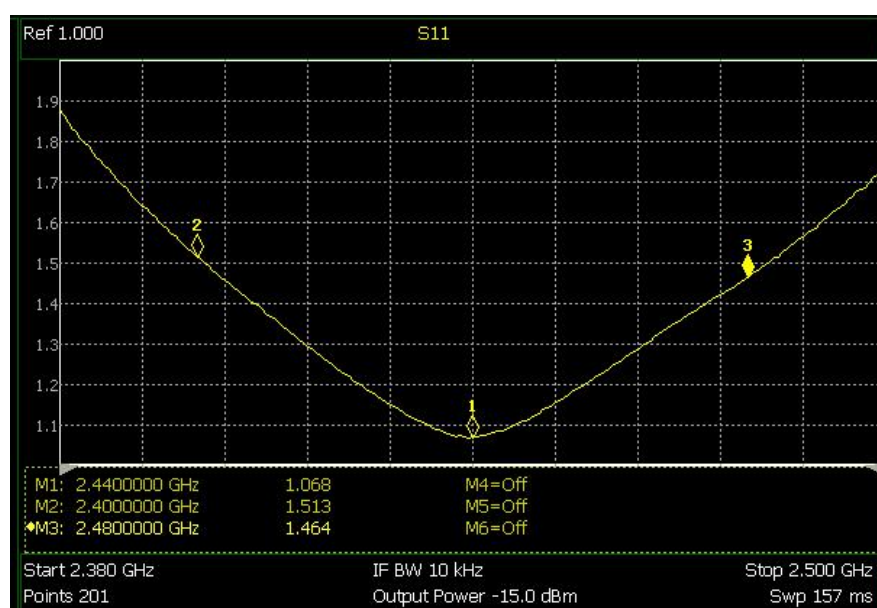
P1

## 6. Electrical Characteristics :

### 回波损耗



### 驻波比



| Mark | Frequency | VSWR  |
|------|-----------|-------|
| 1    | 2400 MHz  | 1.513 |
| 2    | 2440 MHz  | 1.068 |
| 3    | 2480 MHz  | 1.464 |

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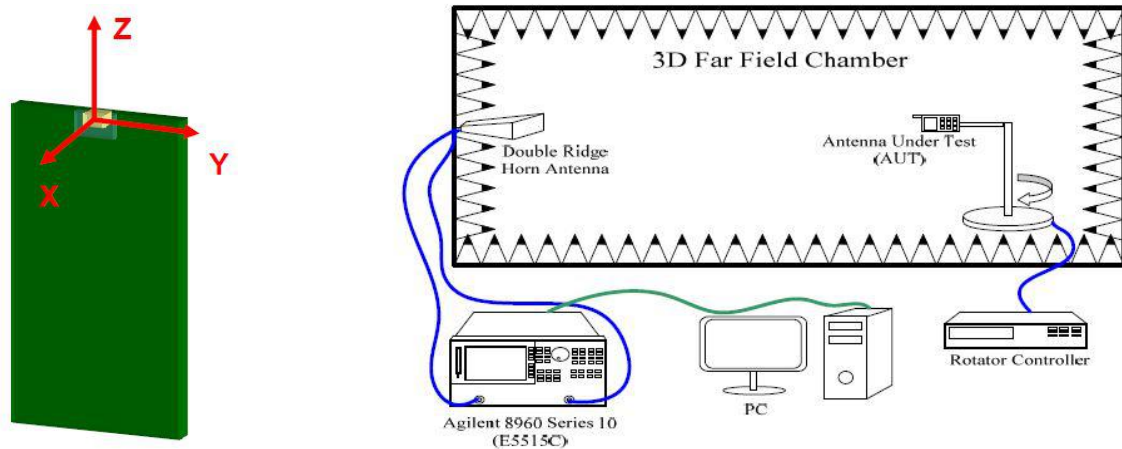
3216

SPEC REV.

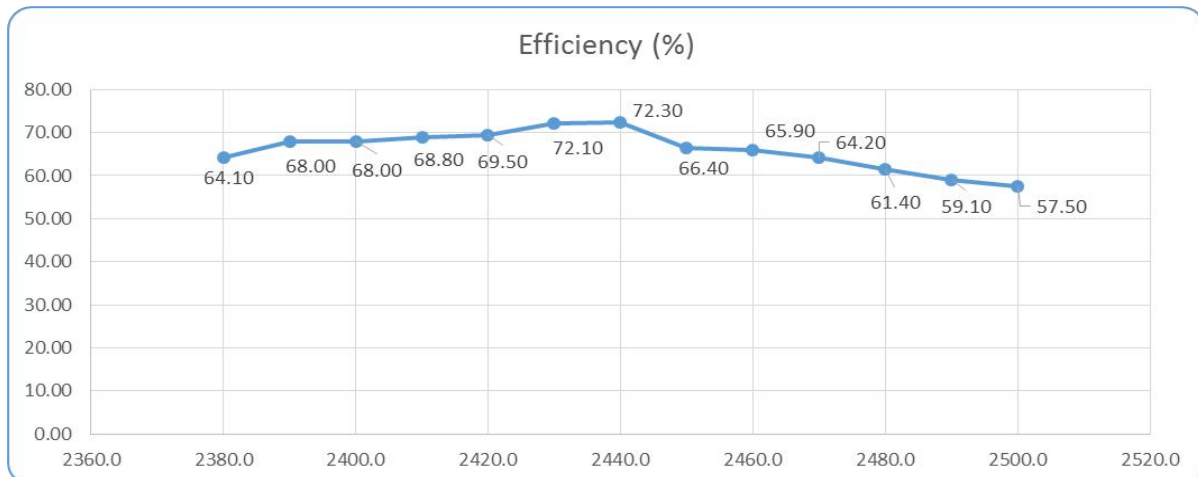
P1

## Radiation Pattern

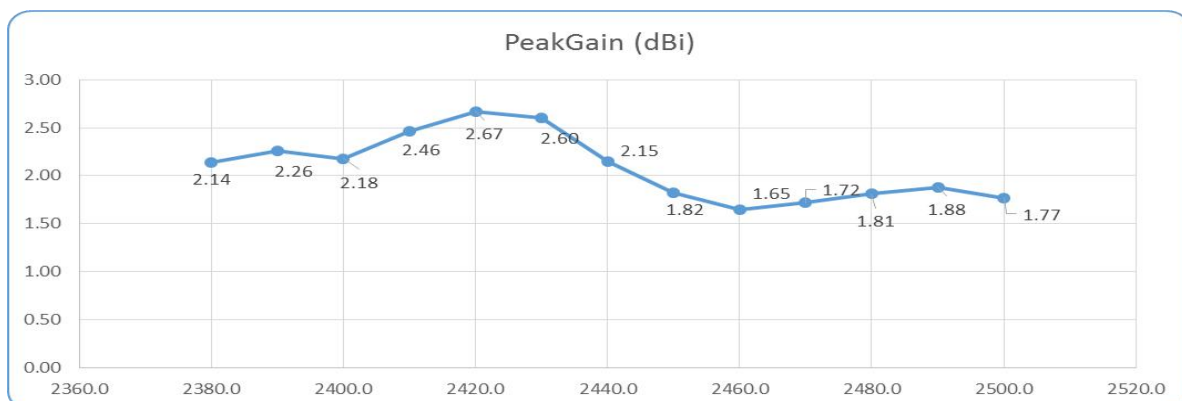
The Gain pattern is measured in FAR-field chamber. DUT is placed on the table of rotator,a standard horn antenna and Vector Network Analyzer is used to collect data.



## ◎ 效率



## 最大增益



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 ANGLES = ±      HOLES DIA = ±

SCALE: N/A

UNIT: mm

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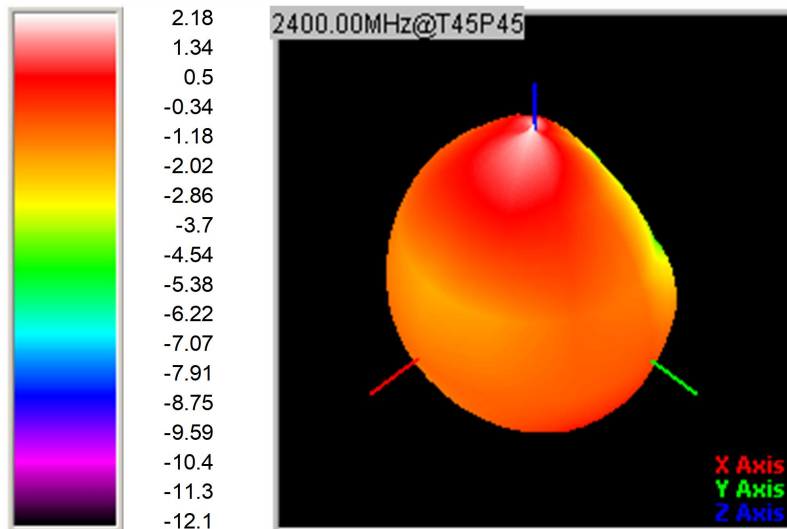
DOCUMENT NO.

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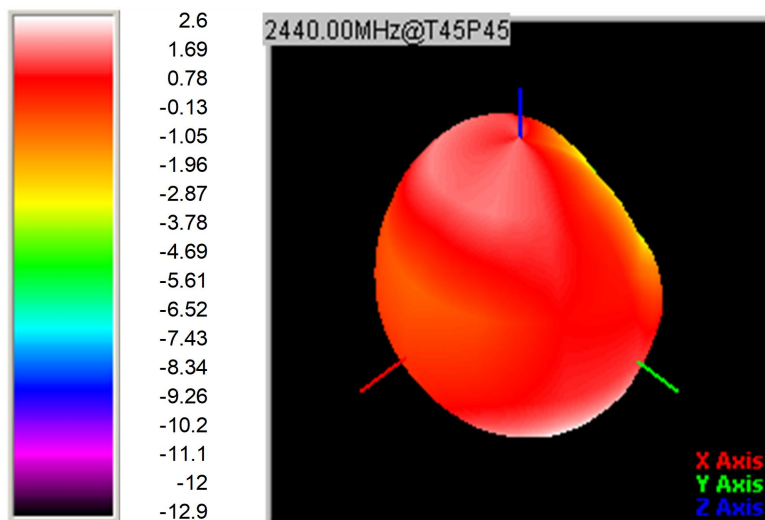
SPEC REV.

P1

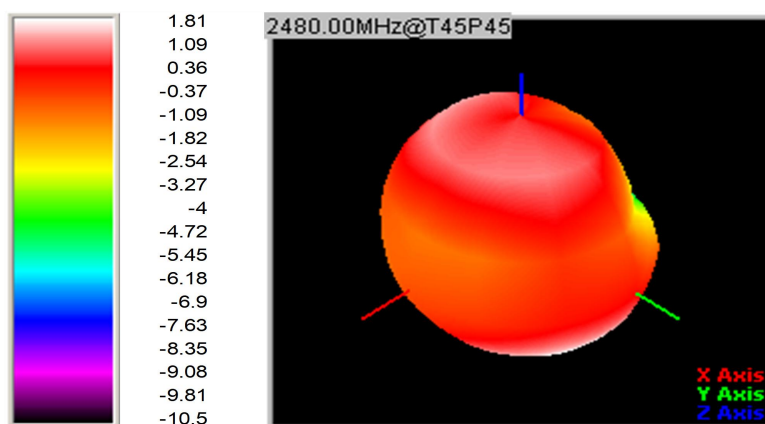
## ◎ 3D Gain Pattern (2400 MHz)



## ◎ 3D Gain Pattern (2440 MHz)



## ◎ 3D Gain Pattern (2480 MHz)



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ANGLES = ±      HOLEDIA = ±

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UNIT: mm

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## 7. Environmental Characteristics

### (1) Reliability Test

| Item                        | Condition                                                                                                                                                                                                                                                                                        | Specification                                                  |
|-----------------------------|--------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|----------------------------------------------------------------|
| Thermal shock               | 1. $30 \pm 3$ minutes at $-40^{\circ} \text{C} \pm 5^{\circ} \text{C}$ ,<br>2. Convert to $+105^{\circ} \text{C}$ (5 minutes)<br>3. $30 \pm 3$ minutes at $+105^{\circ} \text{C} \pm 5^{\circ} \text{C}$ ,<br>4. Convert to $-40^{\circ} \text{C}$ (5 minutes)<br>5. Total 100 continuous cycles | No apparent damage<br>Fulfill the electrical spec. after test. |
| Humidity resistance         | 1. Humidity: 85% R.H.<br>2. Temperature: $85 \pm 5^{\circ} \text{C}$<br>3. Time: 1000 hours.                                                                                                                                                                                                     | No apparent damage<br>Fulfill the electrical spec. after test. |
| High temperature resistance | 1. Temperature: $150^{\circ} \text{C} \pm 5^{\circ} \text{C}$<br>2. Time: 1000 hours.                                                                                                                                                                                                            | No apparent damage<br>Fulfill the electrical spec. after test. |
| Low temperature resistance  | 1. Temperature: $-40^{\circ} \text{C} \pm 5^{\circ} \text{C}$<br>2. Time: 1000 hours.                                                                                                                                                                                                            | No apparent damage<br>Fulfill the electrical spec. after test. |
| Soldering heat resistance   | 1. Solder bath temperature : $260 \pm 5^{\circ} \text{C}$<br>2. Bathing time: $10 \pm 1$ seconds                                                                                                                                                                                                 | No apparent damage                                             |
| Solderability               | The dipped surface of the terminal shall be at least 95% covered with solder after dipped in solder bath of $245 \pm 5^{\circ} \text{C}$ for $3 \pm 1$ seconds.                                                                                                                                  | No apparent damage                                             |

### (2) Storage Condition

#### (a) At warehouse:

The temperature should be within  $0 \sim 30^{\circ} \text{C}$  and humidity should be less than 60% RH.

The product should be used within 1 year from the time of delivery.

#### (b) On board:

The temperature should be within  $-40 \sim 85^{\circ} \text{C}$  and humidity should be less than 85% RH.

### (3) Operating Temperature Range

Operating temperature range :  $-40^{\circ} \text{C}$  to  $+105^{\circ} \text{C}$ .

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**ANGLES** =  $\pm$       **HOLE DIA** =  $\pm$



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SCALE: N/A

UNIT: mm

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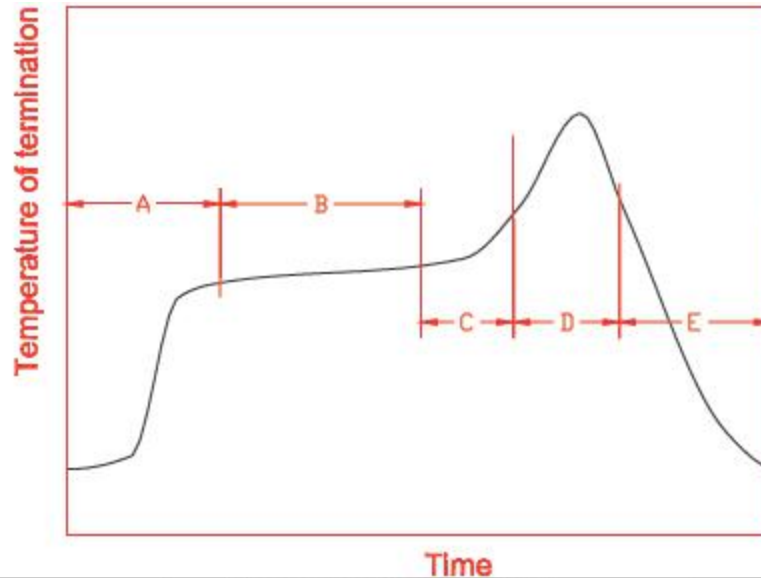
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## 8. Recommended Reflow Soldering



|   |                                    |                                      |               |
|---|------------------------------------|--------------------------------------|---------------|
| A | 1 <sup>st</sup> rising temperature | The normal to Preheating temperature | 30s to 60s    |
| B | Preheating                         | 140°C to 160°C                       | 60s to 120s   |
| C | 2 <sup>nd</sup> rising temperature | Preheating to 200°C                  | 20s to 40s    |
| D | Main heating                       | if 220°C                             | 50s~60s       |
|   |                                    | if 230°C                             | 40s~50s       |
|   |                                    | if 240°C                             | 30s~40s       |
|   |                                    | if 250°C                             | 20s~40s       |
|   |                                    | if 260°C                             | 20s~40s       |
| E | Regular cooling                    | 200°C to 100°C                       | 1°C/s ~ 4°C/s |

\*reference: J-STD-020C

### (1) Soldering Gun Procedure

Note the follows, in case of using solder gun for replacement.

- The tip temperature must be less than 350° C for the period within 3 seconds by using soldering gun under 30 W.
- The soldering gun tip shall not touch this product directly.

### (2) Soldering Volume

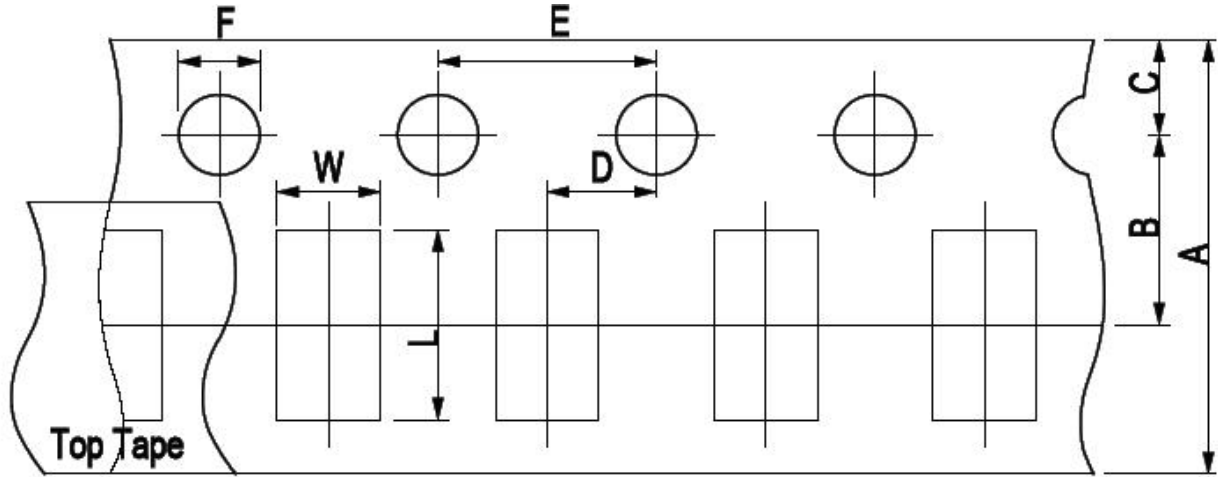
Note that excess of soldering volume will easily get crack the body of this product.

|                                                                                                    |                 |                                                                                                                                                                                                       |              |
|----------------------------------------------------------------------------------------------------|-----------------|-------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|--------------|
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|                                                                                                    |                 |                                                                                                                                                                                                       | SPEC REV. P1 |

## 9. Taping Package and Label Marking: (unit: mm)

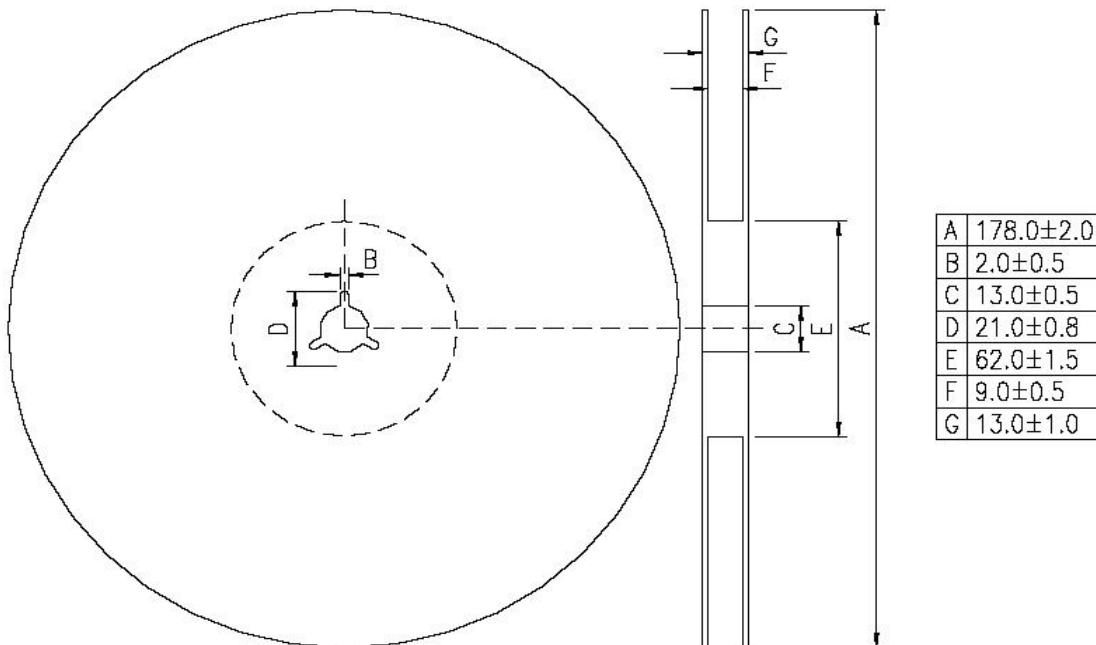
(1) Quantity/Reel: 5000pcs/Reel

(2) Carrier tape dimensions



| Type    | A              | B               | C              | D               | E              | F              | L              | W              |
|---------|----------------|-----------------|----------------|-----------------|----------------|----------------|----------------|----------------|
| 2450-21 | $8.00 \pm 0.3$ | $3.50 \pm 0.05$ | $1.75 \pm 0.1$ | $2.00 \pm 0.05$ | $4.00 \pm 0.1$ | $1.50 \pm 0.1$ | $2.30 \pm 0.1$ | $1.55 \pm 0.1$ |

(3) Taping reel dimensions



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